

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP1580D uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

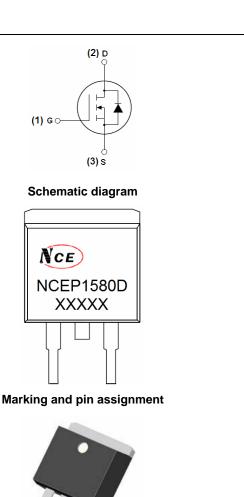
- V_{DS} =150V, I_{D} =80A $R_{DS(ON)}$ <12.5mΩ @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED!

100% ΔVds TESTED!



TO-263-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP1580D	NCEP1580D	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_c=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	150	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	80	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	56.6	Α
Pulsed Drain Current	I _{DM}	320	Α
Maximum Power Dissipation	P _D	210	W
Derating factor		1.4	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	672	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}\!\mathbb{C}$

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NCEP1580D

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	$R_{ heta JC}$	0.71	°C/W	
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	150		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =150V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.5	-	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	10.4	12.5	mΩ
Forward Transconductance	g FS	V _{DS} =10V,I _D =40A	-	38	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ -75\/\/ -0\/	-	3200	-	PF
Output Capacitance	C _{oss}	V_{DS} =75V, V_{GS} =0V, F=1.0MHz	-	382	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVIHZ	-	17.9	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	17	-	nS
Turn-on Rise Time	t _r	V_{DD} =75 V , I_D =40 A	-	35	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =4.7 Ω	-	32	-	nS
Turn-Off Fall Time	t _f		-	9	-	nS
Total Gate Charge	Qg	\/ 75\/ L 40A	-	44.1		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=75V, I_{D}=40A,$	-	19.6		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	7.1		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =80A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	80	Α
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C$, $I_F = I_S$	-	58		nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	_	138		nC

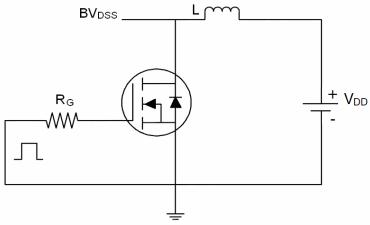
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=0.5mH,Rg=25 Ω

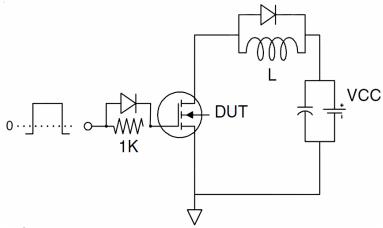


Test Circuit

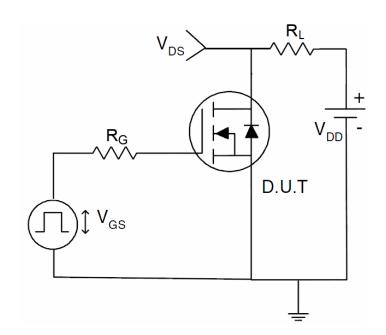
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics

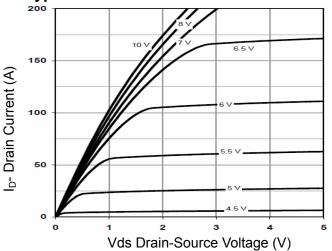


Figure 1 Output Characteristics

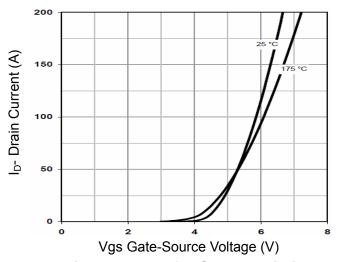


Figure 2 Transfer Characteristics

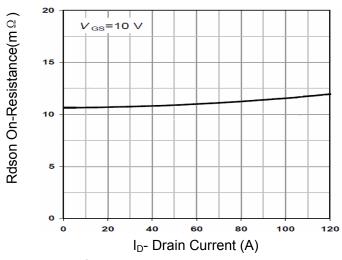


Figure 3 Rdson- Drain Current

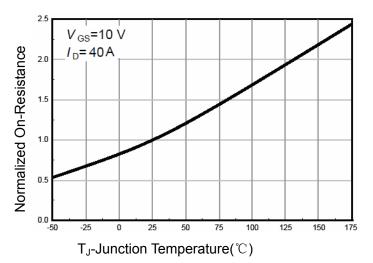


Figure 4 Rdson-JunctionTemperature

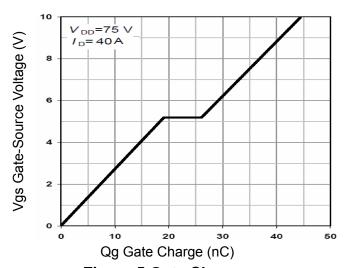


Figure 5 Gate Charge

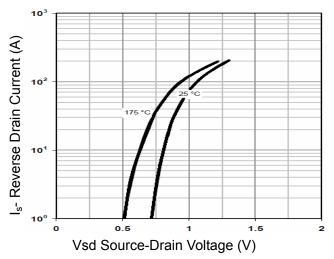


Figure 6 Source- Drain Diode Forward



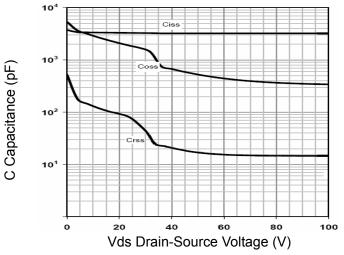


Figure 7 Capacitance vs Vds

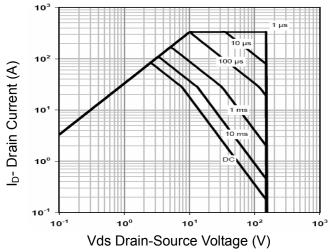


Figure 8 Safe Operation Area

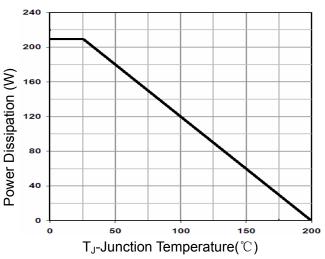


Figure 9 Power De-rating

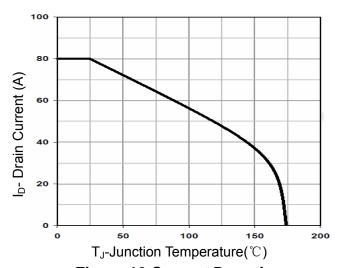
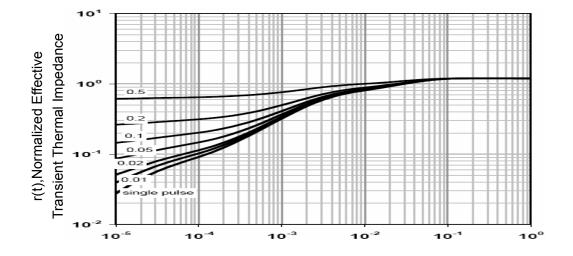


Figure 10 Current De-rating

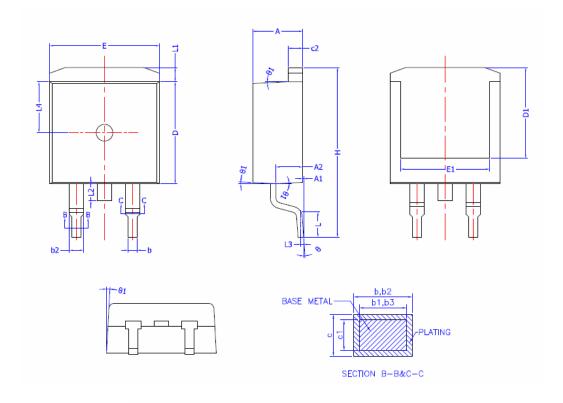


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



TO-263-2L Package Information

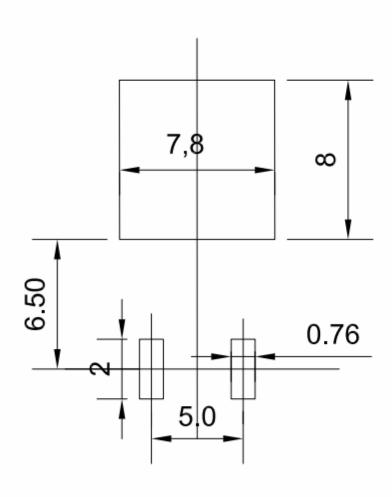


COMMON DIMENSIONS (UNITS OF MEASURE =MILLIMETER)

SYMBOL	MIN	NOM	MAX	
Α	4.40	4.50	4.60	
A1	0	0.10	0.25	
A2	2,20	2,40	2,60	
b	0,76	_	0,89	
b1	0,75	0,80	0,85	
b2	1,23		1,37	
b3	1,22	1,27	1,32	
С	0,47	_	0,60	
c1	0.46	0.51	0.56	
c2	1,25	1.30	1.35	
D	9,10	9.20	9.30	
D1	8,00	_	—	
E	9,80	9.90	10.00	
E1	7.80	_	_	
е	2.54 BSC			
Н	14.90	15.30	15.70	
L	2.00	2,30	2.60	
L1	1.17	1.27	1.40	
L2	_	— 1 <u>.</u> 75		
L3	0.25BSC			
L4	4.60 REF			
θ	0°	— 8°		
θ1	1°	3° 5°		



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